



# CLOVER DISPLAY LTD.

## SPECIFICATION

### FOR

### LCD MODULE

**MODEL NO. : M9127**

**SPEC. REVISION NO. : 00**

**SAMPLE NO. : 01**

### CUSTOMER APPROVAL

Please kindly find & approve the samples & specification and return one copy of this page with authorized signature & company stamp.

DEPARTMENT	NAME	SIGNATURE	EFFECTIVE DATE
PREPARED BY	YAMAHA YAM		14 October 2003
APPROVED BY	WY TSANG		14 October 2003

ADDRESS : ROOM 1006, 10/F WESTIN CENTRE, 26 HUNG TO ROAD, KWUN TONG, KOWLOON, HONG KONG.

TEL : (852) 2341 3238 (SALES OFFICE) (852) 2342 8228 (GENERAL OFFICE)

FAX : (852) 2357 4237 (SALES OFFICE) (852) 2341 8785 (GENERAL OFFICE)

E-MAIL : [cdl@cloverlcd.com](mailto:cdl@cloverlcd.com)

URL : <http://www.cloverlcd.com>

**SPECIFICATION REVISION RECORD**

<b>Revision No.</b>	<b>Description</b>	<b>Date(DD/MM/YY)</b>
00	1 <sup>st</sup> Issue	14/10/03

**SAMPLE REVISION RECORD**

<b>Sample No.</b>	<b>Description</b>	<b>Date(DD/MM/YY)</b>
00	Prototype Sample	25/09/03
01	1 <sup>st</sup> Issue	15/10/03

**GENERAL DESCRIPTION**

Display mode	:	128 x 64 dots Graphic COG LCD module STN / Transflective / Grey
Interface	:	8 bit parallel (6800 mode)
Driving method	:	1/65 duty, 1/9 bias
Viewing direction	:	6 O'clock
Backlight	:	EL/ Blue
Controller IC	:	Samsung S6B0724 For the detailed information, please refer to the IC specifications.

**MECHANICAL DIMENSIONS**

Item	Dimension	Unit	Item	Dimension	Unit
Outline Dimension	34.4(L)x31.6(W)x2.6(Max)(H)	mm	Dot Pitch	0.22(L)x0.30 (W)	mm
Viewing Area	30.4(L)x20.9 (W)	mm	Dot Size	0.195(L)x0.275(W)	mm

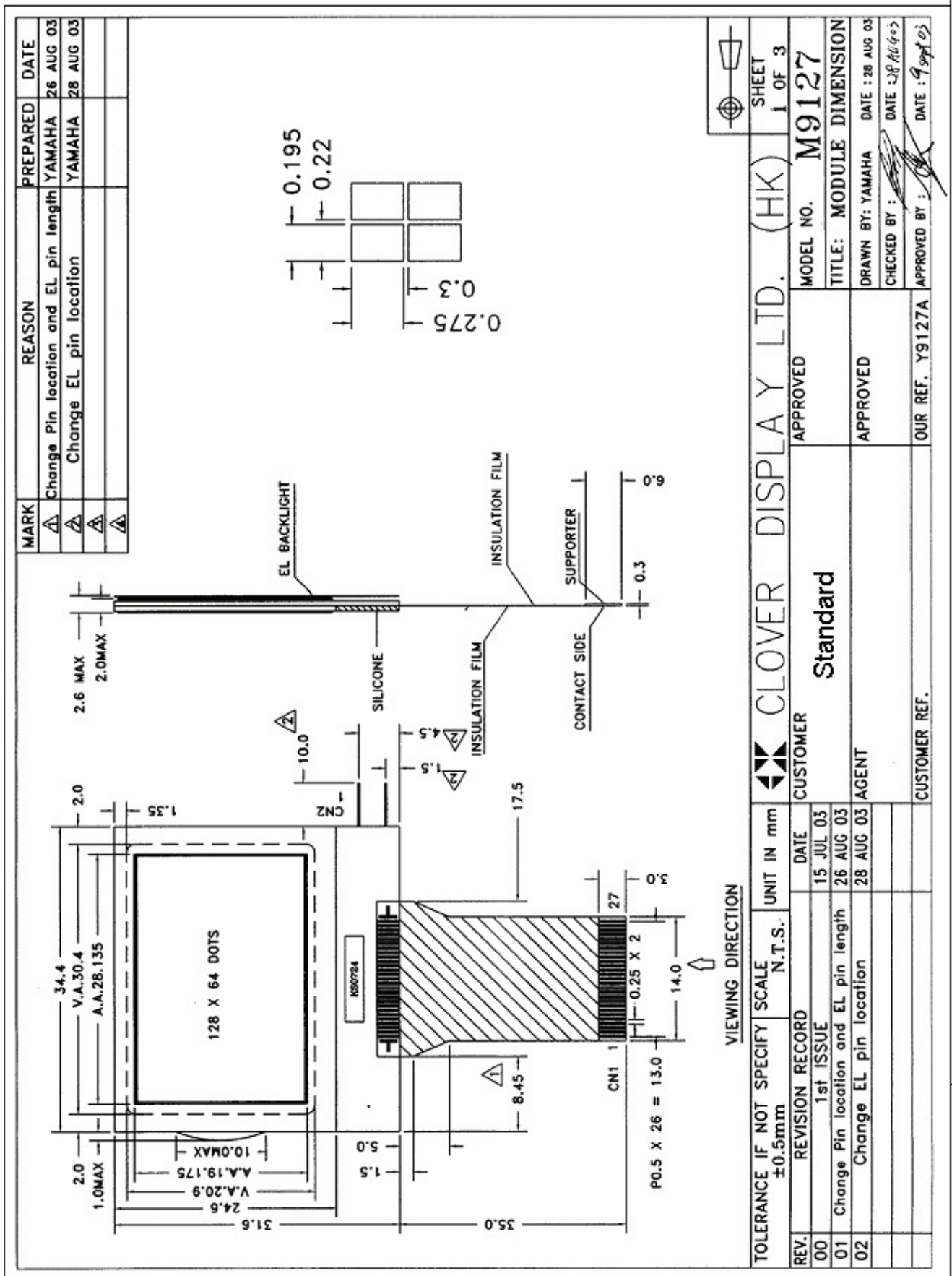
**CONNECTOR PIN ASSIGNMENT (CN1)**

Pin No.	Symbol	Function	Pin No.	Symbol	Function
1	V0	LCD Operation Voltage	15	DB7	Data Bus Line
2	V4		16	DB6	
3	V3		17	DB5	
4	V2		18	DB4	
5	V1		19	DB3	
6	C2-	Voltage Converter	20	DB2	
7	C2+		21	DB1	
8	C1+		22	DB0	
9	C1-		23	E_RDB	Enable Pin
10	C3+		24	RW_WRB	Read/Write
11	VOUT	Voltage Converter input/output	25	RS	Register Selection Pin
12	VSS	Power Supply (0V)	26	RESETB	Reset pin
13	VCI	Reference voltage for the voltage converter	27	CS2	Chip selection
14	VDD	Power Supply for Logic	—	—	—

**CONNECTOR PIN ASSIGNMENT (CN2)**

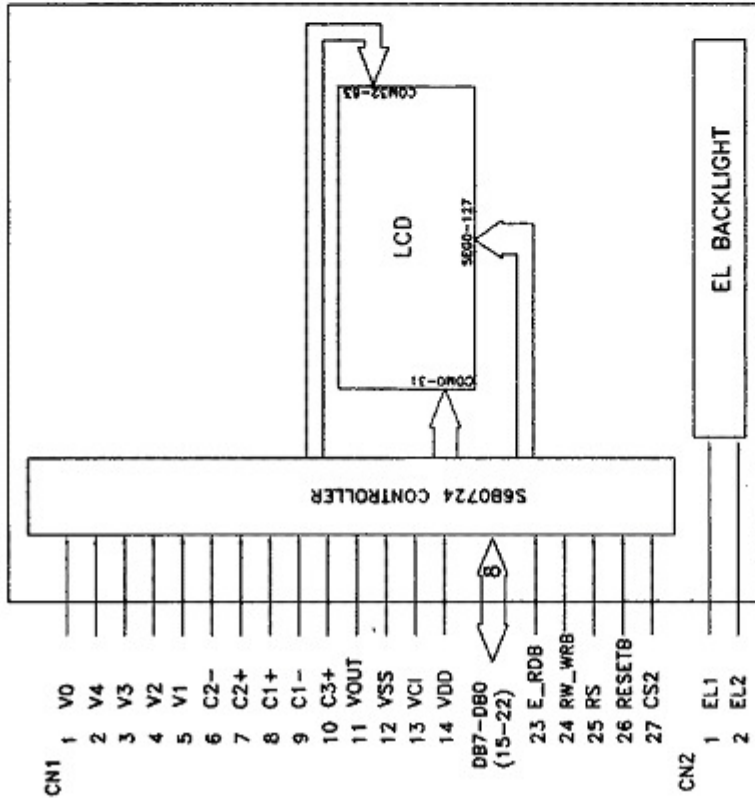
Pin No.	Symbol	Function
1	EL1	Supply voltage for EL
2	EL2	

COUNTER DRAWING OF MODULE DIMENSION



COUNTER DRAWING OF PIN OUT & BLOCK DIAGRAM

BLOCK DIAGRAM



CN1	PIN NUMBER	SYMBOL	FUNCTION
	1	V0	Operating Voltage for LCD
	2	V4	
	3	V3	
	4	V2	
	5	V1	Voltage Converter
	6	C2-	
	7	C2+	
	8	C1+	
	9	C1-	Voltage Converter Input/Output
	10	C3+	
	11	VOUT	
	12	VSS	
	13	VCI	Power Supply (0V)
	14	VDD	Reference voltage for the Voltage Converter
	15	DB7	Power Supply for Logic
	16	DB6	
	17	DB5	
	18	DB4	
	19	DB3	Data Bus Line
	20	DB2	
	21	DB1	
	22	DB0	
	23	E_RDB	Enable Pin
	24	RW_WRB	Read/Write
	25	RS	Register Selection Pin
	26	RESETB	Reset Pin
	27	CS2	Chip Selection

CN2	PIN NUMBER	SYMBOL	FUNCTION
	1	EL1	Supply Voltage for EL
	2	EL2	Supply Voltage for EL

TOLERANCE IF NOT SPECIFY SCALE ±0.5mm		UNIT IN mm	CLOVER DISPLAY LTD. (HK)		SHEET 2 OF 3
REV.	REVISION RECORD	DATE	CUSTOMER	APPROVED	MODEL NO. M9127
00	1st ISSUE	15 JUL 03	Standard		TITLE: PIN OUT & BLOCK DIAGRAM
01	Change Pin location and EL pin length	26 AUG 03	AGENT	APPROVED	DRAWN BY: YAMAHA DATE: 26 AUG 03
02	Change EL pin location	28 AUG 03			CHECKED BY: DATE: 28 AUG 03
			CUSTOMER REF.	OUR REF. Y9127A	APPROVED BY: DATE: 9 Sept 03

**ELECTRICAL CHARACTERISTICS**

Condition: VSS=0V, Ta=25°C

Item	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage	VDD	2.4	3.3	3.6	V
Supply Current	IDD	—	150	200	uA
Operating Voltage for LCD	VO	7.8	8.0	8.2	V
“High”Level Input Voltage	VIH	0.8VDD	—	VDD	V
“Low”Level Input Voltage	VIL	0	—	0.2VDD	V
Backlight Voltage	VEL	—	110	—	Vrms
Backlight Frequency	FEL	—	400	—	Hz

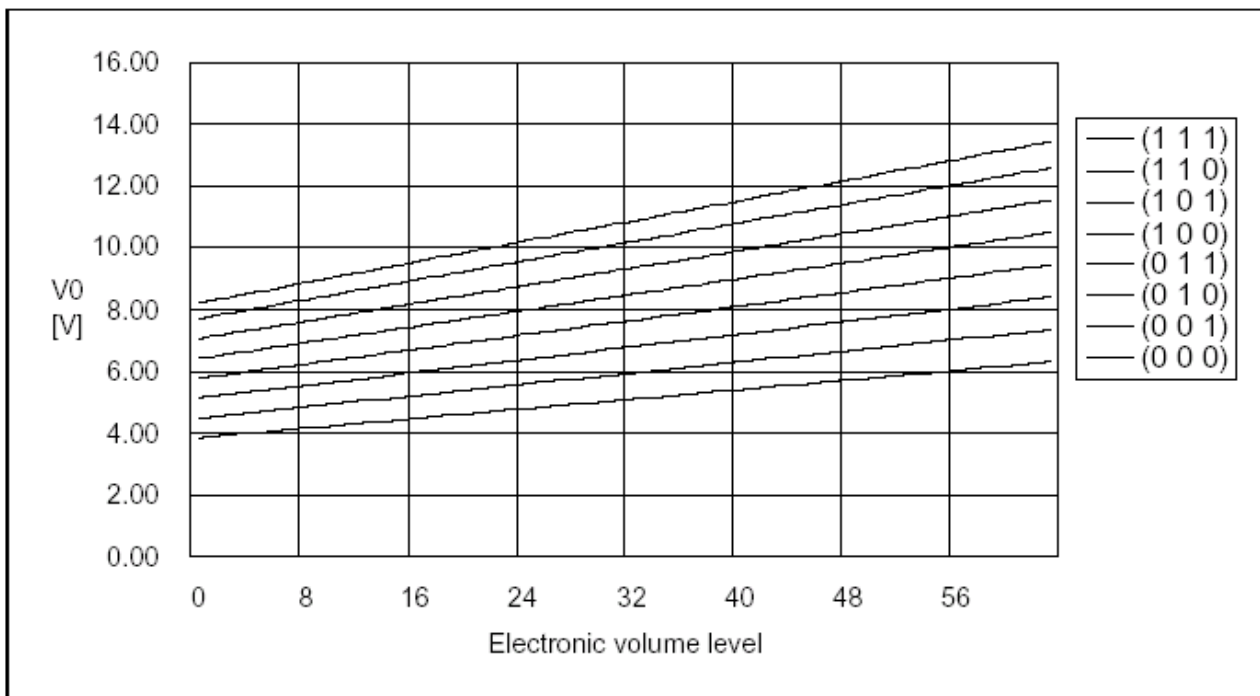
**Regulator resistor select register: (R2, R1, R0) = (1,0,0)**

**Reference voltage register set = 18H (Heximals) for typical VLCD 8.0V**

**Internal Rb / Ra Ratio depending on 3-bit Data ( R2 R1 R0 )**

	3-bit data settings (R2 R1 R0)							
	0 0 0	0 0 1	0 1 0	0 1 1	1 0 0	1 0 1	1 1 0	1 1 1
<b>1+(Rb / Ra)</b>	3.0	3.5	4.0	4.5	5.0	5.5	6.0	6.4

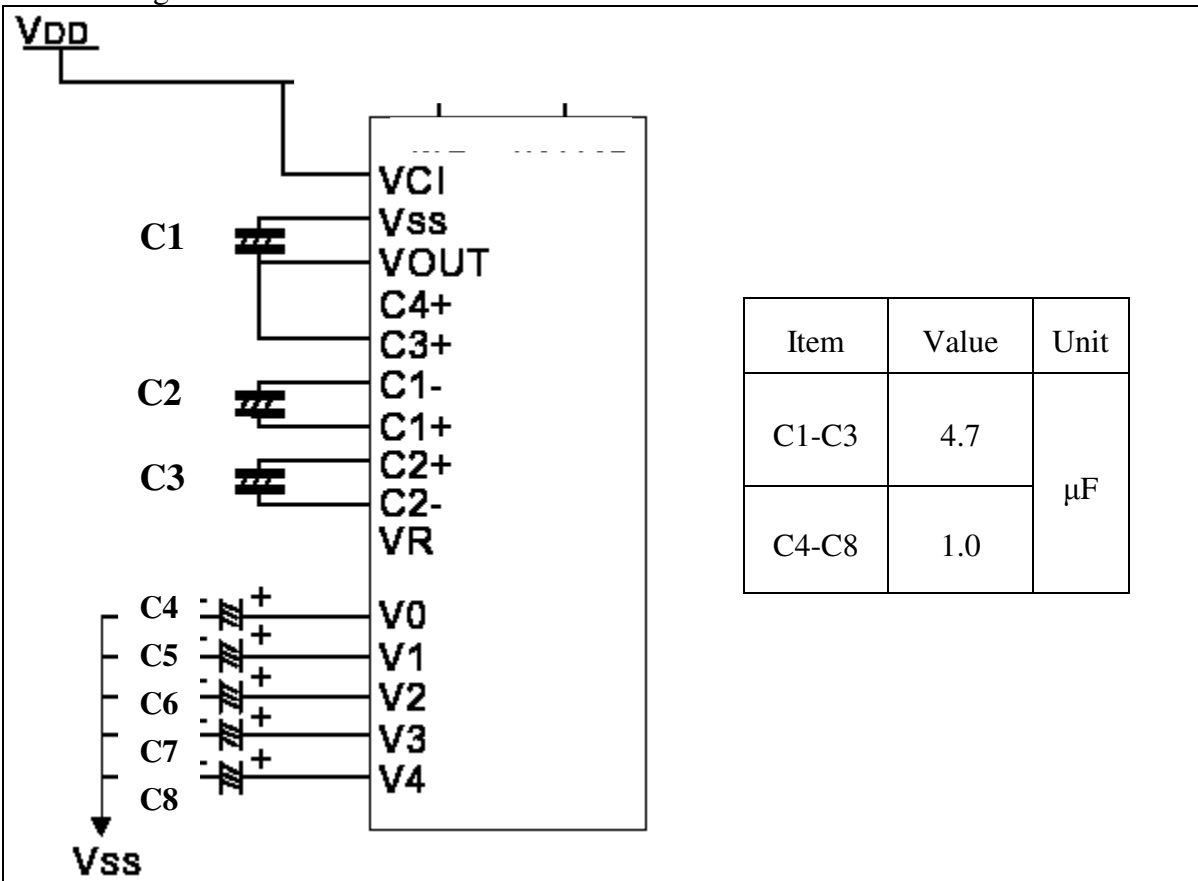
The following figure shows VO voltage measured by adjusting internal regulator resistor ratio (Rb / Ra) and 6-bit electronic volume registers for each temperature coefficient at Ta = 25 °C.



**Electronic Volume Level**

**REFERENCE CIRCUIT EXAMPLES**

3X Boosting Circuit



**ABSOLUTE MAXIMUM RATINGS**

Please make sure not to exceed the following maximum rating values under the worst application conditions

Item	Symbol	Rating	Unit
Supply Voltage	VDD	-0.3 to 7.0	V
Input Voltage	VT	-0.3 to VDD +0.3	V
Operating Temperature	T <sub>opr</sub>	0 to 50	°C
Storage Temperature	T <sub>stg</sub>	-10 to 60	°C

## COMMAND TABLE

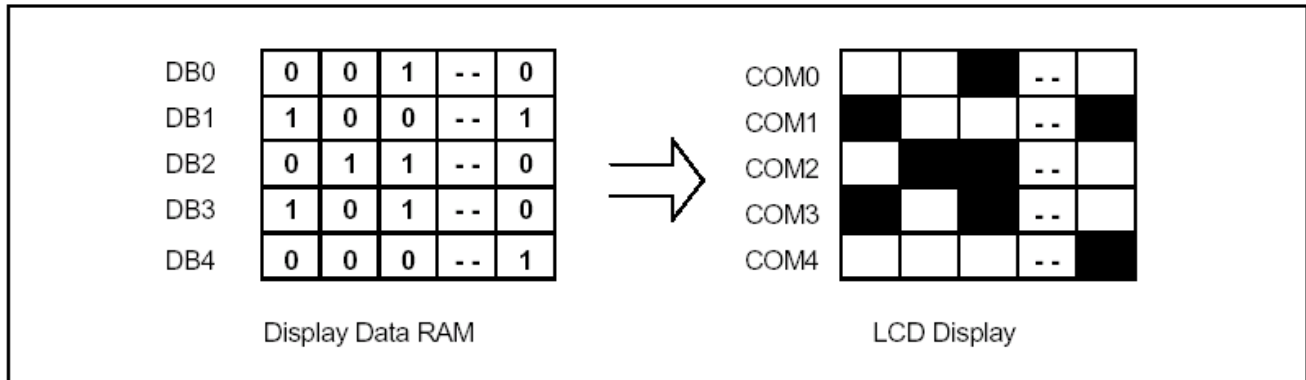
×: Don't care

Instruction	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Description
Display ON / OFF	0	0	1	0	1	0	1	1	1	DON	Turn on/off LCD panel When DON = 0: display OFF When DON = 1: display ON
Initial display line	0	0	0	1	ST5	ST4	ST3	ST2	ST1	ST0	Specify DDRAM line for COM0
Set page address	0	0	1	0	1	1	P3	P2	P1	P0	Set page address
Set column address MSB	0	0	0	0	0	1	Y7	Y6	Y5	Y4	Set column address MSB
Set column address LSB	0	0	0	0	0	0	Y3	Y2	Y1	Y0	Set column address LSB
Read status	0	1	BUSY	ADC	ONOFF	RESETB	0	0	0	0	Read the internal status
Write display data	1	0	Write data								Write data into DDRAM
Read display data	1	1	Read data								Read data from DDRAM
ADC select	0	0	1	0	1	0	0	0	0	ADC	Select SEG output direction When ADC = 0: normal direction (SEG0→SEG131) When ADC = 1: reverse direction (SEG131→SEG0)
Reverse display ON / OFF	0	0	1	0	1	0	0	1	1	REV	Select normal / reverse display When REV = 0: normal display When REV = 1: reverse display
Entire display ON / OFF	0	0	1	0	1	0	0	1	0	EON	Select normal/entire display ON When EON = 0: normal display. When EON = 1: entire display ON
LCD bias select	0	0	1	0	1	0	0	0	1	BIAS	Select LCD bias
Set modify-read	0	0	1	1	1	0	0	0	0	0	Set modify-read mode
Reset modify-read	0	0	1	1	1	0	1	1	1	0	release modify-read mode
Reset	0	0	1	1	1	0	0	0	1	0	Initialize the internal functions
SHL select	0	0	1	1	0	0	SHL	×	×	×	Select COM output direction When SHL = 0: normal direction (COM0→COM63) When SHL = 1: reverse direction (COM63→COM0)
Power control	0	0	0	0	1	0	1	VC	VR	VF	Control power circuit operation
Regulator resistor select	0	0	0	0	1	0	0	R2	R1	R0	Select internal resistance ratio of the regulator resistor
Set reference voltage mode	0	0	1	0	0	0	0	0	0	1	Set reference voltage mode
Set reference voltage register	0	0	×	×	SV5	SV4	SV3	SV2	SV1	SV0	Set reference voltage register
Set static indicator mode	0	0	1	0	1	0	1	1	0	SM	Set static indicator mode
Set static indicator register	0	0	×	×	×	×	×	×	S1	S0	Set static indicator register
Power save	-	-	-	-	-	-	-	-	-	-	Compound instruction of display OFF and entire display ON
Instruction	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Description
NOP	0	0	1	1	1	0	0	0	1	1	<i>Non-Operation command</i>
Test Instruction_1	0	0	1	1	1	1	×	×	×	×	<i>Don't use this instruction</i>
Test Instruction_2	0	0	1	0	0	1	×	×	×	×	<i>Don't use this instruction</i>



## DISPLAY DATA RAM

The Display Data RAM stores pixel data for the LCD. It is 65-row by 132-column addressable array. Each pixel can be selected when the page and column addresses are specified. The 65 rows are divided into 8 pages of 8 lines and the 9th page with a single line (DB0 only). Data is read from or written to the 8 lines of each page directly through DB0 to DB7. The display data of DB0 to DB7 from the microprocessor correspond to the LCD common lines as shown in figure 6. The microprocessor can read from and write to RAM through the I/O buffer. Since the LCD controller operates independently, data can be written into RAM at the same time as data is being displayed without causing the LCD flicker.



### Page Address Circuit

This circuit is for providing a Page Address to DISPLAY-DATA-RAM shown in figure 8. It incorporates 4-bit Page Address register changed by only the "Set Page" instruction. Page Address 8 (DB3 is "H", but DB2, DB1 and DB0 are "L") is a special RAM area for the icons and display data DB0 is only valid. When Page Address is above 8, it is impossible to access to on-chip RAM.

### Line Address Circuit

This circuit assigns DDRAM a Line Address corresponding to the first line (COM0) of the display. Therefore, by setting line address repeatedly, it is possible to realize the screen scrolling and page switching without changing the contents of on-chip RAM as shown in figure 8. It incorporates 6-bit line address register changed by only the initial display line instruction and 6-bit counter circuit. At the beginning of each LCD frame, the contents of register are copied to the line counter which is increased by CL signal and generates the Line Address for transferring the 132-bit RAM data to the display data latch circuit. However, display data of icons are not scrolled because the MPU can not access Line Address of icons.

**Column Address Circuit**

Column Address circuit has an 8-bit preset counter that provides column address to the Display Data RAM as shown in figure 8. When set Column Address MSB / LSB instruction is issued, 8-bit [Y7:Y0] is updated. And, since this address is increased by 1 each a read or write data instruction, microprocessor can access the display data continuously. However, the counter is not increased and locked if a non-existing address above 84H. It is unlocked if a column address is set again by set Column Address MSB / LSB instruction. And the Column Address counter is independent of page address register.

ADC select instruction makes it possible to invert the relationship between the Column Address and the segment outputs. It is necessary to rewrite the display data on built-in RAM after issuing ADC Select instruction. Refer to the following figure 7.

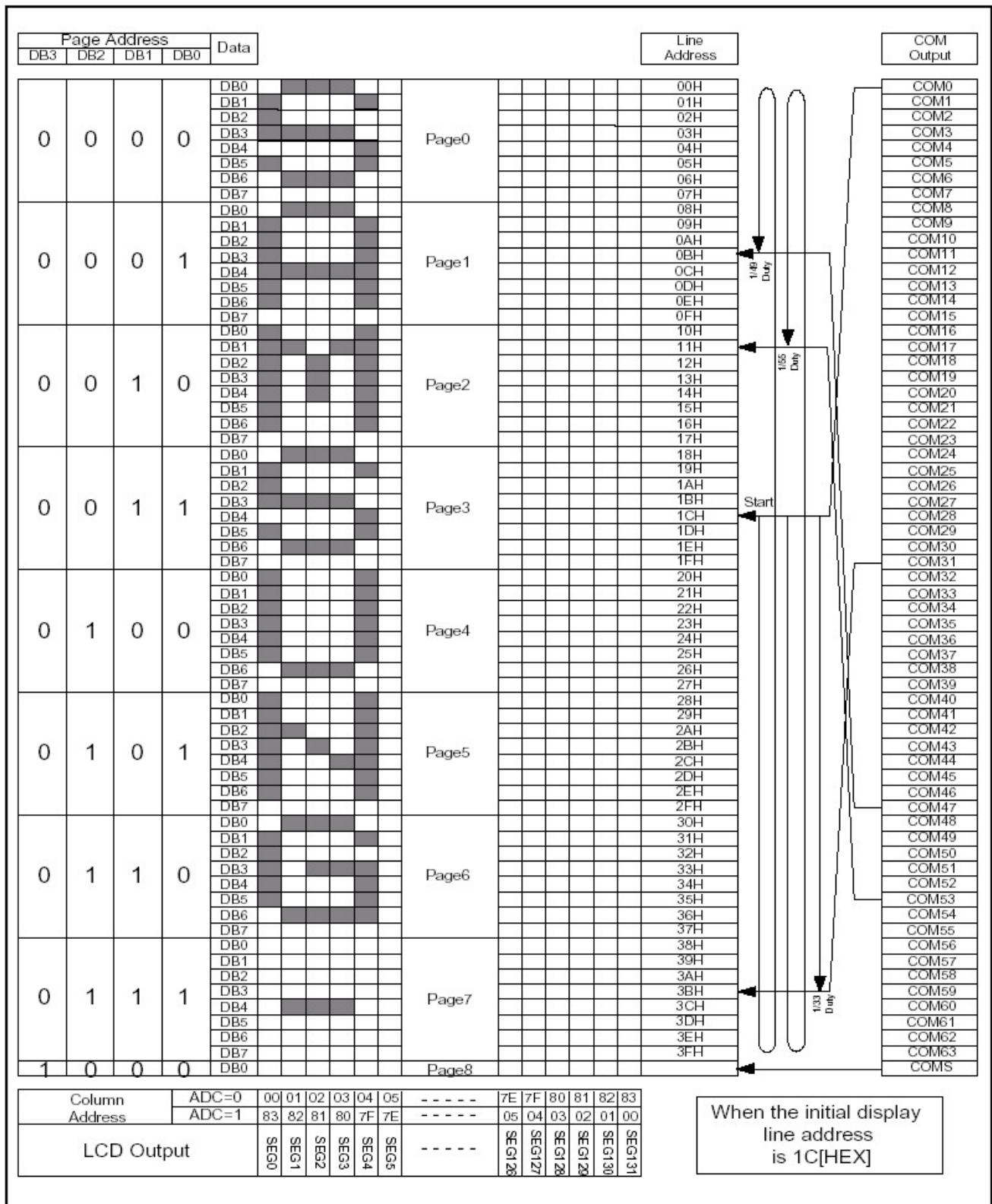
SEG output	SEG 0	SEG 1	SEG 2	SEG 3	... ..	SEG 128	SEG 129	SEG 130	SEG 131
Column address [Y7:Y0]	00H	01H	02H	03H	... ..	80H	81H	82H	83H
Display data	1	0	1	0		1	1	0	0
LCD panel display (ADC = 0)					... ..				
LCD panel display (ADC = 1)					... ..				

**The Relationship between the Column Address and the Segment Outputs**

**Segment Control Circuit**

This circuit controls the display data by the display ON / OFF, reverse display ON / OFF and entire display ON / OFF instructions without changing the data in the display data RAM.

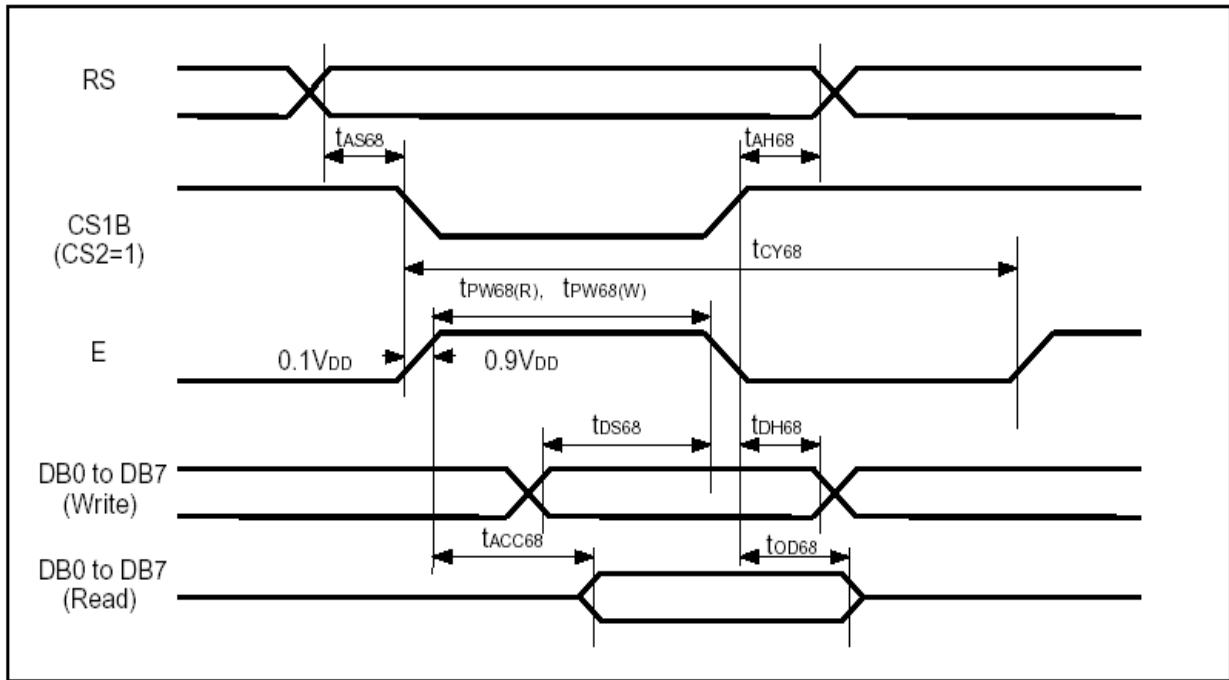
DISPLAY DATA RAM MAP



Display Data RAM Map

**AC CHARACTERISTICS**

**Read / Write Characteristics (6800-series Microprocessor)**

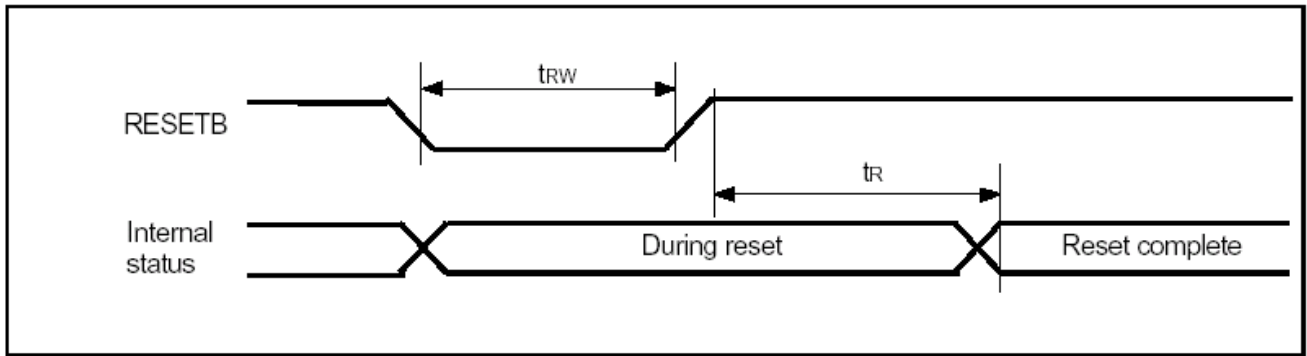


**Read / Write Characteristics (6800-series Microprocessor)**

(VDD = 2.4 to 3.6V, Ta = -40 to +85°C)

Item	Signal	Symbol	Min.	Typ.	Max.	Unit	Remark
Address setup time	RS	tAS68	0	-	-	ns	
Address hold time		tAH68	0	-	-	ns	
System cycle time	RS	tCY68	300	-	-	ns	
Data setup time	DB7 to DB0	tDS68	40	-	-	ns	
Data hold time		tDH68	15	-	-	ns	
Access time	DB0	tACC68	-	-	140	ns	CL = 100 pF
Output disable time		tOD68	10	-	100	ns	
Enable pulse width	Read Write	tPW68(R)	120	-	-	-	
		tPW68(W)	60	-	-	-	

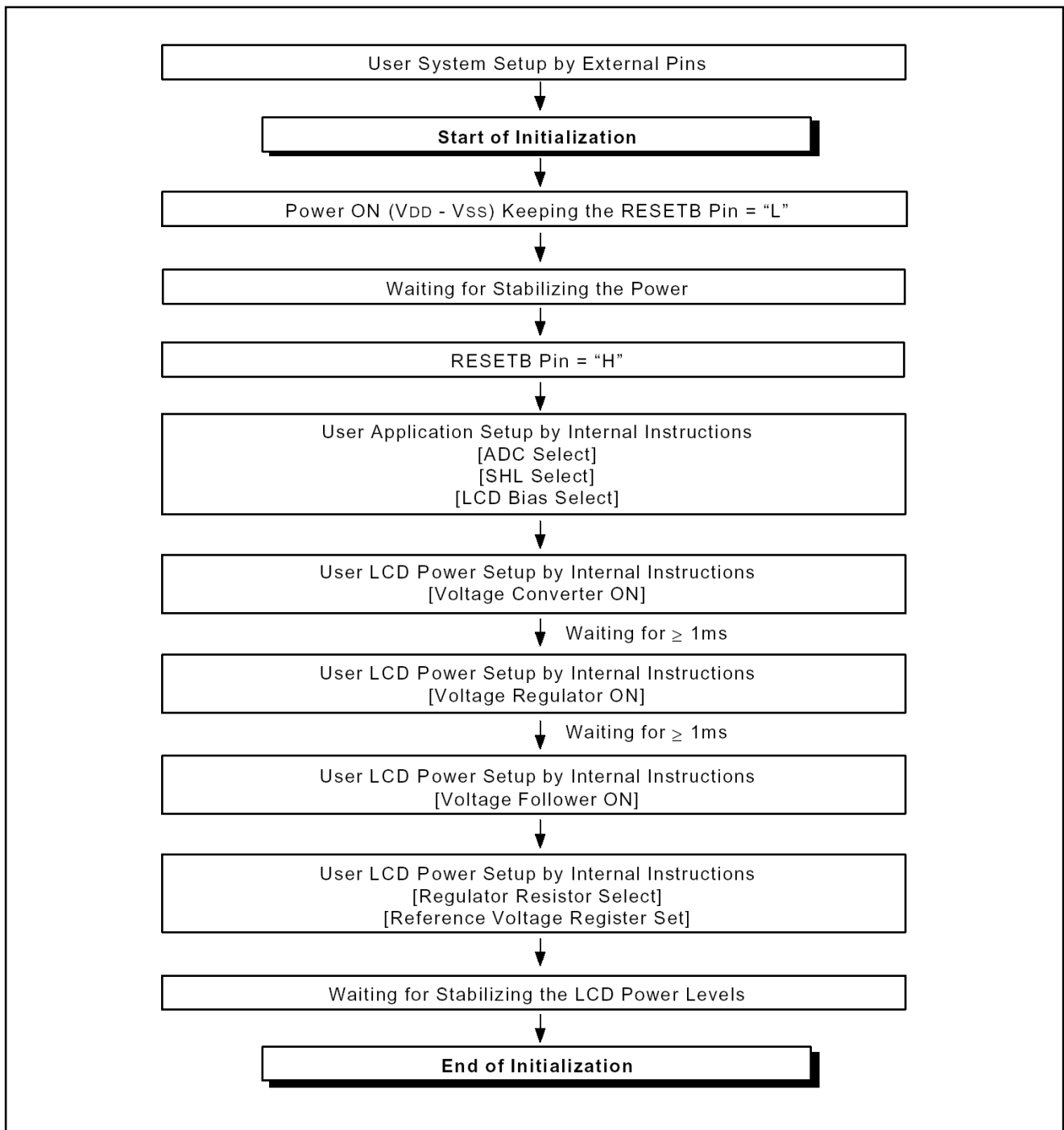
**RESET INPUT TIMING**



( $V_{DD} = 2.4$  to  $3.6V$ ,  $T_a = -40$  to  $+85^{\circ}C$ )

Item	Signal	Symbol	Min.	Typ.	Max.	Unit	Remark
Reset low pulse width	RESETB	$t_{RW}$	1.0	-	-	ns	
Reset time	-	$t_R$	-	-	1.0	ns	

## INITIALIZATION



Initializing with the Built-in Power Supply Circuits

**ELECTRO-OPTICAL CHARACTERISTICS**

MEASURING CONDITION: POWER SUPPLY =  $V_{OP} / 64 \text{ Hz}$   
 TEMPERATURE =  $22 \pm 5 \text{ }^\circ\text{C}$   
 RELATIVE HUMIDITY =  $60 \pm 15 \%$

ITEM	SYMBOL	UNIT	TYP.
RESPONSE TIME	T <sub>on</sub>	ms	220
	T <sub>off</sub>	ms	280
CONTRAST RATIO	Cr	-	12
VIEWING ANGLE (6 O'clock) (Cr ≥ 2)	V3:00	°	40
	V6:00	°	70
	V9:00	°	40
	V12:00	°	50

THE ELECTRO-OPTICAL CHARACTERISTICS ARE MEASURED VALUE BUT NOT GUARANTEED ONES.

**RELIABILITY OF LCD MODULE**

ITEM	TEST CONDITION	TIME
High temperature operating	50°C	240 hours
Low temperature operating	0°C	240 hours
High temperature storage	60°C	240 hours
Low temperature storage	-10°C	240 hours
Temperature-humidity storage	40°C 90% R.H.	96 hours
Temperature cycling	-10°C to 60°C 30 Min Dwell	5 cycles
Vibration Test at LCM Level	Freq 10-55 Hz Sweep rate: 10-55-10 at 1 min Sweep mode Linear Displacement: 2 mm p-p 1 Hour each for X, Y, Z	—

**SAMPLING METHOD**

SAMPLING PLAN: MIL-STD 105E

CLASS OF AQL: LEVEL II/ SINGLE SAMPLING  
 MAJOR-0.65% MINOR – 1.5%

QUALITY STANDARD

DEFECT	CRITERIA	TYPE	FIGURE
SHORT CIRCUIT	-	MAJOR	-
MISSING SEGMENT	-	MAJOR	-
UNEVEN / POOR CONTRAST	-	MAJOR	-
CROSS TALK	-	MAJOR	-
PIN HOLE	$MAX(a,b) \leq 1/4 W$	MINOR	1
EXCESS SEGMENT	$MAX(c,d) \leq 1/4 T$	MINOR	1
BUBBLES	$d^* \geq 0.2$ QTY=0	MINOR	2
BLACKS SPOTS	$d \leq 0.3$ N.A.** $0.3 < d \leq 0.4$ QTY $\leq 1$ $0.4 < d$ QTY=0	MINOR	2
LINE SCRATCHES	$x \geq 0.7$ $y \geq 0.05$ QTY=0	MINOR	3
BLACK LINE	$x \geq 0.7$ $y \geq 0.05$ QTY=0	MINOR	3

\*d = MAX (d<sub>1</sub>,d<sub>2</sub>)

\*\* N. A . = NOT APPLICABLE

DEFECT TABLE : B

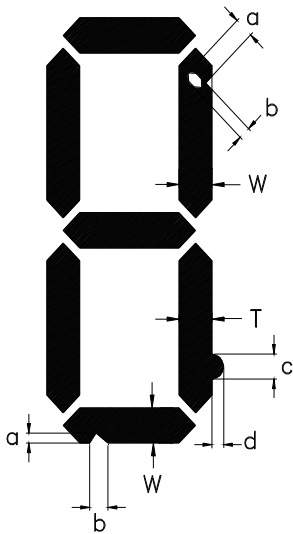
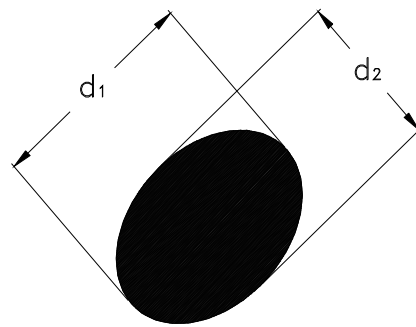
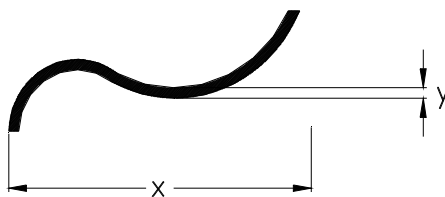


fig . 1



POLARIZER BUBBLES / SPOTS  
fig . 2



LINE SCRATCHES / BLACK LINE  
fig . 3



QUALITY STANDARD ( CONT . )

DEFECT		CRITERIA	TYPE	FIGURE
CHIPS	CONTACT EDGE	$e \leq 1/2T$ $f \leq 1/3W$ $g \leq 3.5$	MINOR	4
	BOTTOM GLASS	$p \leq 1.0$ $q \leq 3.5$ $r \leq 1/2T$		4
	CORNER	$a \leq 1.5$ $b \leq W$		4
	TOP GLASS	$a \leq 3.0$ $b \leq 1/3T$ $c \leq 1/2W$		5
GLASS PROTRUSION		$a \leq 1/4 W$	MINOR	6
RAINBOW		-	MINOR	-

UNLESS STATE OTHERWISE , ALL UNIT ARE IN MILLIMETER .

DEFECT TABLE : B

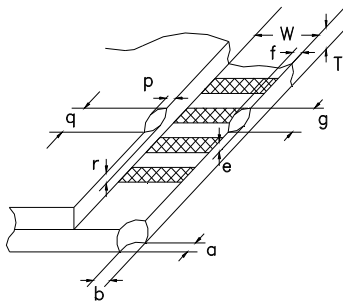


fig . 4

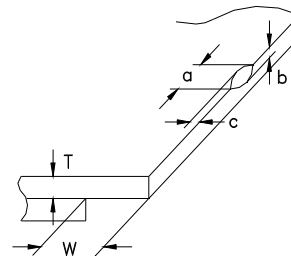


fig . 5

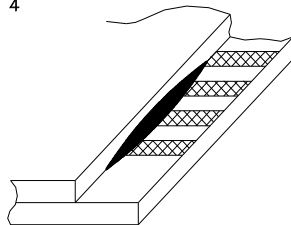


fig . 6

## HANDLING PRECAUTIONS

### (1) CAUTION OF LCD HANDLING & CLEANING

Use soft cloth with solvent (recommended below) to clean the display surface and wipe lightly.

- Isopropyl alcohol, ethyl alcohol, trichlorotrifluoroethane

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface. Do not use the following solvent;

-water, ketone, aromatics

### (2) CAUTION AGAINST STATIC CHARGE

The LCD modules use CMOS LSI drivers, so customers are recommend that any unused input terminal would be connected to  $V_{DD}$  or  $V_{SS}$ , do not input any signals before power is turned on, and ground your body, work/assembly areas, assembly equipment to protect against static electricity.

Remove the protective film slowly and, if possible, under ESD control device like ion blower and humidity of working room should be kept over 50%RH to reduce risk of static charge.

### (3) PACKAGING

Avoid intense shock and falls from a height and do not operate or store them exposed direct to sunshine or high temperature/humidity.

### (4) CAUTION FOR OPERATION

It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage than the limit causes the shorter LCD life. The use of direct current drive should be avoided because an electrochemical reaction due to direct current causes LCD's undesirable deterioration.

Response time will be extremely delayed at low temperature, and LCD's show dark color at high temperature. However those phenomena do not mean malfunction or out of order with LCD's.

Some font will be abnormally displayed when the display area is pushed hard during operation. But it resumes normal condition after turning off once.

### (5) SOLDERING (for Pin type)

It is recommended to complete dip soldering at 270 °C or hand soldering at 280 °C within 3 seconds. The soldering position is at least 3mm apart from the pin head. Wave or reflow soldering are not recommended. Metal pins should not be soldered for more than 3 times and each soldering should be done after cool down of metal pins

### (6) SAFETY

For crash damaged or unnecessary LCD's, it is recommended to wash off liquid crystal by either of solvents such as acetone and ethanol and should be burned up later.

When any liquid leaked out of a damaged glass cell comes in contact with your hands, wash it off with soap and water.

## WARRANTY

CLOVER will replace or repair any of her LCD modules in accordance with her LCD specification for a period of one year from date of shipment. The warranty liability of Clover is limited to repair and/or replacement. Clover will not be responsible for any subsequent or consequential event.